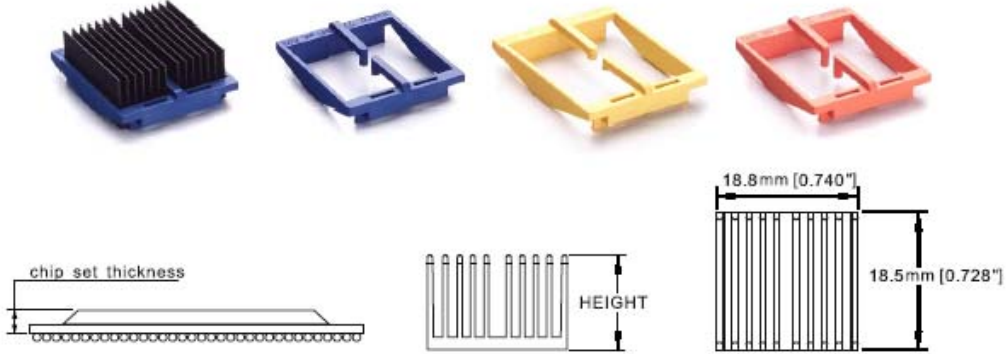


Specification		BGA Heat Sink for 19x19 chip set				
						
<p>■ Heat sink material : AL6063</p> <p>■ Finish : Black Anodize</p> <p>■ Chip set package thickness and clip color : 2.1mm~2.6mm ----- Yellow clip 1.5mm~2.0mm ----- Blue clip 0.9mm~1.4mm ----- Orange clip</p> <p>■ Accessory : Clip material ----- Plastic(94V0) Thermal pad ----- T725 17x17mm [0.669\"</p>	Part number	Length (mm) [Inch]	Width (mm) [Inch]	Total height (mm) [Inch]	Base (mm) [Inch]	Clip color
	CMS311919-06-01	18.8 [0.740\"]	18.7 [0.736\"]	6.3 [0.248\"]	1.7 [0.066\"]	Yellow
	CMS311919-06-02					Blue
	CMS311919-06-03					Orange
	CMS311919-10-01	18.8 [0.740\"]	18.5 [0.728\"]	9.5 [0.374\"]	1.7 [0.066\"]	Yellow
	CMS311919-10-02					Blue
	CMS311919-10-03					Orange
	CMS311919-13-01	18.8 [0.740\"]	18.5 [0.728\"]	12.7 [0.500\"]	1.7 [0.066\"]	Yellow
	CMS311919-13-02					Blue
	CMS311919-13-03					Orange

Performance		Heat Source(LxW):15x15mm	
